

IGBT

SGH15N120RUF

Short Circuit Rated IGBT

General Description

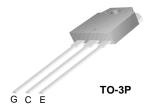
Fairchild's RUF series of Insulated Gate Bipolar Transistors (IGBTs) provide low conduction and switching losses as well as short circuit ruggedness. The RUF series is designed for applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short circuit ruggedness is a required feature.

Features

- Short circuit rated 10 μ s @ T_C = 100°C, V_{GE} = 15V
- High speed switching
- Low saturation voltage : $V_{CE(sat)} = 2.3 \text{ V} @ I_{C} = 15 \text{A}$
- High input impedance

Applications

AC & DC motor controls, general purpose inverters, robotics, and servo controls.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGH15N120RUF	Units
V _{CES}	Collector-Emitter Voltage		1200	V
V _{GES}	Gate-Emitter Voltage		± 25	V
	Collector Current	@ T _C = 25°C	24	А
IC	Collector Current	@ T _C = 100°C	15	А
I _{CM (1)}	Pulsed Collector Current		45	Α
	Short Circuit Withstand Time	@ T _C = 100°C	10	μs
T _{SC}	Maximum Power Dissipation	$@ T_C = 25^{\circ}C$	180	W
	Maximum Power Dissipation	@ T _C = 100°C	72	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.69	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chai	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 1mA$	1200			V
$\Delta B_{VCES}/$ ΔT_J	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0V, I _C = 1mA		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			1	mA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Char	acteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 15$ mA, $V_{CE} = V_{GE}$	3.5	5.5	7.5	V
	Collector to Emitter	$I_C = 15A$, $V_{GE} = 15V$		2.3	3.0	V
$V_{CE(sat)}$	Saturation Voltage	$I_C = 24A$, $V_{GE} = 15V$		2.8		V
Dynamic	c Characteristics					
C _{ies}	Input Capacitance	V - 20V V - 0V		1400		pF
C _{oes}	Output Capacitance	$V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz		135		pF
C _{res}	Reverse Transfer Capacitance	1 = 1MH2		45		pF
t _{d(on)}	ng Characteristics Turn-On Delay Time			20		ns
t _r	Rise Time	-		60		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 600 \text{ V}, I_{C} = 15\text{A},$		60	110	ns
t _f	Fall Time	$R_G = 20\Omega$, $V_{GE} = 15V$,		150	300	ns
Ė _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		1.0		mJ
E _{off}	Turn-Off Switching Loss			0.98		mJ
E _{ts}	Total Switching Loss			1.98	2.8	mJ
t _{d(on)}	Turn-On Delay Time			20		ns
t _r	Rise Time			70		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 600 \text{ V}, I_{C} = 15\text{A},$		80	150	ns
t _f	Fall Time	$R_G = 20\Omega, V_{GE} = 15V,$		200	400	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C		1.13		mJ
E _{off}	Turn-Off Switching Loss	1		1.50		mJ
E _{ts}	Total Switching Loss]		2.63	3.81	mJ
T _{sc}	Short Circuit Withstand Time	V _{CC} = 600 V, V _{GE} = 15V @ T _C = 100°C	10			μs
Qg	Total Gate Charge	V 600 V I 454		72	108	nC
Q _{ge}	Gate-Emitter Charge	$V_{CE} = 600 \text{ V}, I_{C} = 15\text{A},$ $V_{GF} = 15\text{V}$		10	15	nC
Q _{gc}	Gate-Collector Charge	vGE = 13 v		30	45	nC
	Internal Emitter Inductance	Measured 5mm from PKG		14		nH

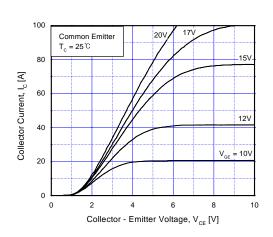
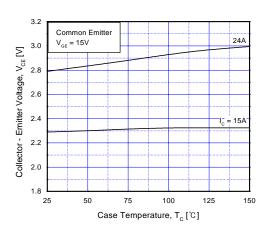


Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics



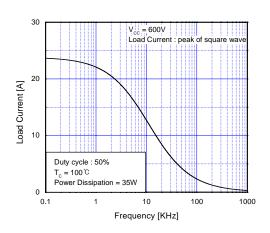
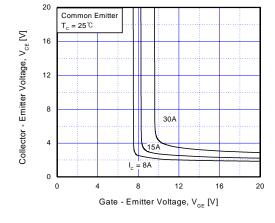


Fig 3. Saturation Voltage vs. Case
Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency



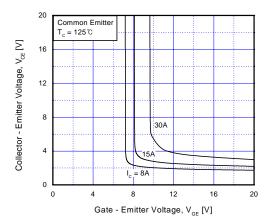
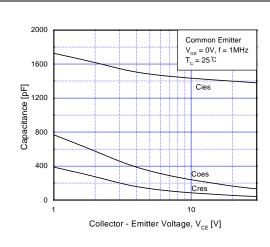


Fig 5. Saturation Voltage vs. V_{GE}

Fig 6. Saturation Voltage vs. V_{GE}

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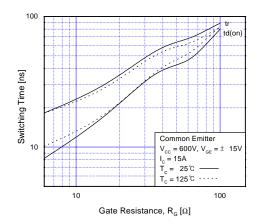
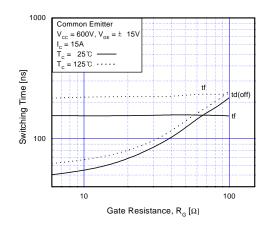


Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance



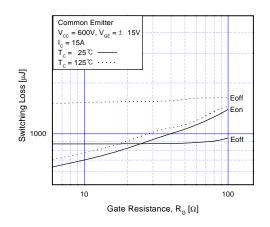
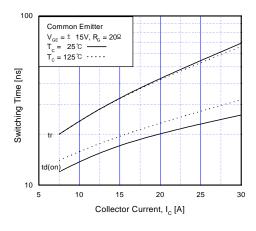


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



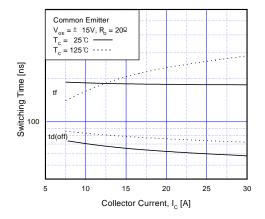
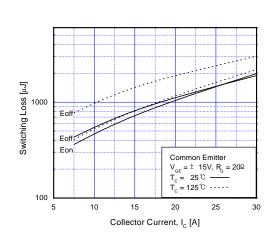


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs.
Collector Current



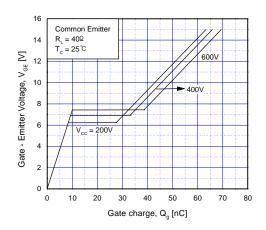
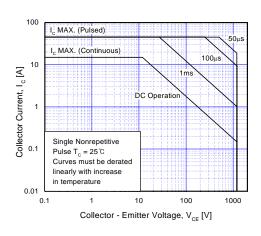


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



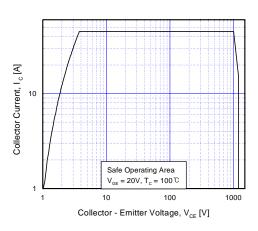


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA

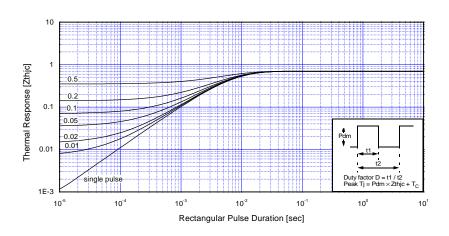
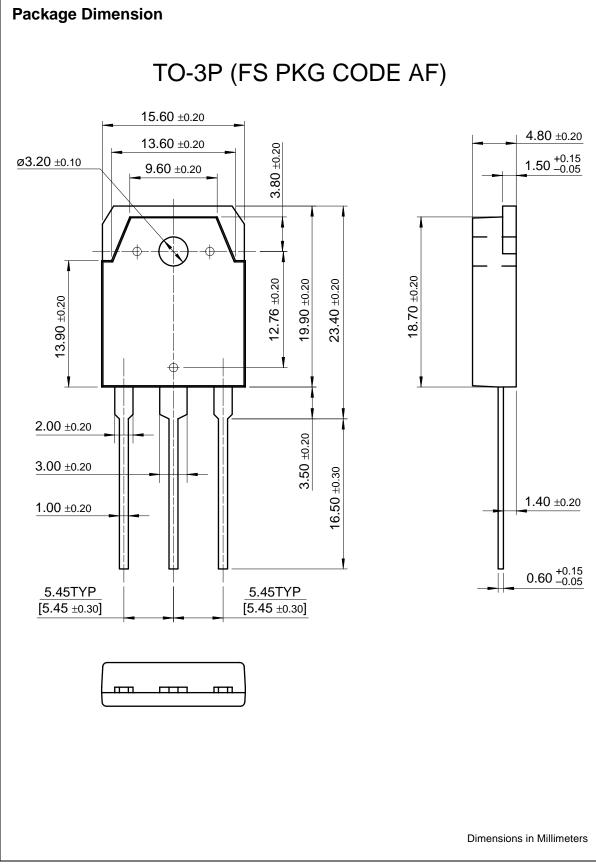


Fig 17. Transient Thermal Impedance of IGBT



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